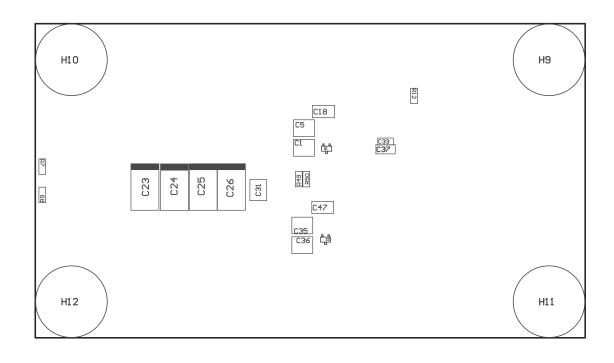


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP11196	REV: A	SUN REV:	Not In VersionControl	
	TID #: PMP11196				
PLOT NAME = Top Assembly Drawing	GENERATED : 7/10/2	015 5:12:52	PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP11196	REV: A	SUN REV:	Not In VersionControl	
	TID #: PMP11196				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 7/10/2	015 5:12:53	PM	TEXAS INSTRUMENTS	

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